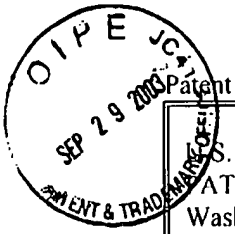


9-29-03



Attorney Docket No. MTI-31607

U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE Washington, D.C. 20231  <b>SUPPLEMENTAL          INFORMATION DISCLOSURE          STATEMENT BY APPLICANT          (SEPT. - 2003)</b>	ATTY. DOCKET NO.	Serial No.
	MTI-31607	10/050,507
	Applicant	Confirmation No.
	Lee, Teck Kheng	7687
	Filing Date	Group Art Unit
	January 16, 2002	2813

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CAT	5,347,159	09/13/94	Khandros			
CAT	5,679,977	10/21/97	Khandros			
CAT	5,683,942	11/04/97	Kata			
CAT	5,777,391	07/07/98	Nakamura			
CAT	5,905,303	05/18/99	Kata			
CAT	6,217,343	04/17/01	Okuno			

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Examiner Initials	Document Number	Publication Date	Country	Int'l Class	Sub-Class	Translation (Yes/No)
CAT	EP684644	11/29/95	EPO			
CAT	EP1009027	06/14/00	EPO			
CAT	KR 2001054744	07/02/01	Korea			English Abstract

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Examiner Initials	Non-Patent Document

Examiner Initials	<i>Craig 9-22</i>	Date Considered	<i>4-4-5</i>
EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.			

4-25-03

Patent

Attorney Docket No. MTI-31607



U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE Washington, D.C. 20231  <b>SUPPLEMENTAL          INFORMATION DISCLOSURE          STATEMENT BY APPLICANT          (04-2003)</b>	ATTY. DOCKET NO.	Serial No.
	MTI-31607	10/050,507
	Applicant	Confirmation No.
	Lee, Teck Kheng	7687
	Filing Date	Group Art Unit
	01-16-02	2813

## U.S. PATENT DOCUMENTS

Examiner Initial	Patent Number	Issue Date	Patentee	U.S. Class	Sub-Class	Filing Date

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Examiner Initial	Publ. Number	Publ. Date	Applicant	U.S. Class	Sub-Class	Filing Date
CAT	US 2002/0142513	Oct. 3, 2002	Fee et al.	438	106	Apr. 19, 2001

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Examiner Initial	Document Number	Publication Date	Country	Int'l Class	Sub-Class	Translation (Yes/No)

## OTHER DOCUMENTS (Including Author, Title, Date, Relevant Pages, Place of Publication)

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EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.	

Patent

3-12-02

Attorney Docket No. MTI-31607

U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE Washington, D.C. 20231  INFORMATION DISCLOSURE STATEMENT BY APPLICANT	ATTY. DOCKET NO.	Serial No.
	MTI-31607	10/050,507
	Applicant	Confirmation No.
	Lee, Teck Kheng	7687
	Filing Date	Group Art Unit
	01-16-02	2812

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CAT	A2	6,048,755	04-11-00	Jiang et al.	438	118	11-12-98
CAT	A3	6,177,723	01-23-01	Eng et al.	257	691	12-17-97
CAT	A4	6,222,265	04-24-01	Akram et al.	257	723	12-17-99
CAT	A5	6,232,666	05-15-01	Corisis et al.	257	774	12-04-98
CAT	A6	6,242,932	06-05-01	Hembree	324	755	02-19-99
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Examiner Initial		Document Number	Publication Date	Country	Int'l Class	Sub-Class	Translation (Yes/No)
	B1						

## OTHER DOCUMENTS (Including Author, Title, Date, Relevant Pages, Place of Publication)

Examiner Initial		Non-Patent Document
	C1	

Examiner Initials <i>Craig A. 20</i>	Date Considered <i>4-4-5</i>
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2-8-05

Patent

Attorney Docket No. MTI-31607

U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE Washington, D.C. 20231  <b>SUPPLEMENTAL          INFORMATION DISCLOSURE          STATEMENT BY APPLICANT</b>  (February 8, 2005)	ATTY. DOCKET NO.	Serial No.
	MTI-31607	10/050,507
	Applicant	Confirmation No.
	Lee, Teck Kheng	7687
	Filing Date	Group Art Unit
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Examiner Initials	Patent Number	Publication Date	Patentee or Applicant	U.S. Class	Sub-Class
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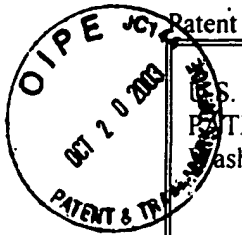
Examiner Initials	Document Number	Publication Date	Country	Name of Patentee or Applicant	Translation (Yes/No)
CAT	JP 04030456	02/1992	Japan	Yamaguchi	Yes (Abstract)
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CAT	EP 0997942 A2	05/2000	EPO	Horiuchi et al.	
CAT	JP 02000230964	08/2000	Japan	Hikita	Yes (Abstract)

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10-20-03



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U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE Washington, D.C. 20231  <b>SUPPLEMENTAL          INFORMATION DISCLOSURE          STATEMENT BY APPLICANT          (OCT 2003)</b>	ATTY. DOCKET NO.	Serial No.
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	January 16, 2002	2813

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Examiner Initials	Document Number	Publication Date	Country	Int'l Class	Sub- Class	Translation (Yes/No)

## OTHER DOCUMENTS (Including Author, Title, Date, Relevant Pages, Place of Publication)

Examiner Initials	Non-Patent Document

Examiner Initials	<i>Chay A-20</i>	Date Considered	<i>4-4-5</i>
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U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE Alexandria, VA 22313  <b>INFORMATION DISCLOSURE          STATEMENT BY APPLICANT</b>	ATTY. DOCKET NO.	Serial No.
	MTI-31607	10/050,507
	Applicant	Confirmation No.
	Teck Kheng Lee	7687
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CAT	A3	99/65282	12-16-99	WO	H05K	1/11	N/A

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CAT	B3	Andros, F. et al., "TBOA Package Technology," <i>Components, Packaging, and Manufacturing Technology, Part B: IEEE Transactions on Advanced Packaging</i> , Vol. 17, Issue 4, Nov. 1994, pp. 564-568.
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CAT	B7	Geissinger, J. et al., "Tape Based CSP Package Supports Fine Pitch Wirebonding," <i>Electronics Manufacturing Technology Symposium</i> , 2002, IEMT 2002, 27 <sup>th</sup> Annual IEEE/SEMI International, 17-18 July 2002, pp. 41-452.
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CAT	B9	Haug, R. et al., "Low-Cost Direct Chip Attach: Comparison of SMD Compatible FC Soldering with Anisotropically Conductive Adhesive FC Bonding," <i>IEEE Transactions on Electronics Packaging Manufacturing</i> , Vol. 23, No. 1, Jan 2000, pp. 12-18.

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Patent

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U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE Alexandria, VA 22313  <b>INFORMATION DISCLOSURE          STATEMENT BY APPLICANT</b>	ATTY. DOCKET NO.	Serial No.
	MTI-31607	10/050,507
	Applicant	Confirmation No.
	Tock Kheng Lee	7687
	Filing Date	Group Art Unit
	January 16, 2002	2813

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Examiner Initials	<i>Craig A. J. R.</i>	Date Considered	<i>4-4-5</i>
EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.			

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09-09-2004



Patent

Attorney Docket No. MTI-31607

<b>U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE Alexandria, VA 22313</b>  <b>INFORMATION DISCLOSURE STATEMENT BY APPLICANT</b>	<b>ATTY. DOCKET NO.</b>	<b>Serial No.</b>
	MTI-31607	10/050,507
	<b>Applicant</b>	<b>Confirmation No.</b>
	Teck Kheng Lee	7687
	<b>Filing Date</b>	<b>Group Art Unit</b>
	January 16, 2002	2813

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CAT	A4	4,818,728	04/1989	Rai et al.		
CAT	A5	5,366,794	11/1994	Nakao		
CAT	A6	5,385,869	01/1995	Liu et al.		
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SEPT. 20, 2004

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Attorney Docket No. MTI-31607

<b>U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE Alexandria, VA 22313</b>  <b>INFORMATION DISCLOSURE STATEMENT BY APPLICANT</b>	<b>ATTY. DOCKET NO.</b>	<b>Serial No.</b>
	MTI-31607	10/050,507
	<b>Applicant</b>	<b>Confirmation No.</b>
	Teck Kheng Lee	7687
	<b>Filing Date</b>	<b>Group Art Unit</b>
	January 16, 2002	2813

Examiner Initial		Document No.	Publication/ Issue Date	Patentee	U.S. Class	Sub-Class
CAI	A35	5,834,338	11/1998	Takeda et al.		
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Examiner Initial		Document No.	Publication/ Issue Date	Patentee	U.S. Class	Sub-Class
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<del>CAT</del>	A73	6,116,921	09/2000	Scholz et al.		
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Patent

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U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE Alexandria, VA 22313  <b>INFORMATION DISCLOSURE          STATEMENT BY APPLICANT</b>	ATTY. DOCKET NO.	Serial No.
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